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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/075,218	02/14/2002	Thomas S. Kobayashi	SC11931TP	8301
23125 EDEESCALE 9	23125 7590 08/01/2007 FREESCALE SEMICONDUCTOR, INC.		EXAMINER	
LAW DEPAR?	<b>IMENT</b>	•	FARAHANI, DANA	
7700 WEST PA AUSTIN, TX 7	ARMER LANE MD:TX	D:TX32/PL02	ART UNIT	PAPER NUMBER
AUSTIN, IX	16123		2891	
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			MAIL DATE	DELIVERY MODE
			08/01/2007	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

		<i></i>				
	Application No.	Applicant(s)				
	10/075,218	KOBAYASHI ET AL.				
Office Action Summary	Examiner	Art Unit				
	Dana Farahani	2891				
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address				
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DATE - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication.  If NO period for reply is specified above, the maximum statutory period was realiure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tin vill apply and will expire SIX (6) MONTHS from , cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).				
Status						
1) Responsive to communication(s) filed on 18 Ju	<u>ine 2007</u> .					
2a) This action is <b>FINAL</b> . 2b) ⊠ This	This action is <b>FINAL</b> . 2b)⊠ This action is non-final.					
	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.						
Disposition of Claims						
4) ⊠ Claim(s) 1-7,9,11-18,20 and 21 is/are pending 4a) Of the above claim(s) is/are withdray 5) □ Claim(s) is/are allowed. 6) ⊠ Claim(s) 1-7,9,11-18,20 and 21 is/are rejected. 7) □ Claim(s) is/are objected to. 8) □ Claim(s) are subject to restriction and/o	wn from consideration.					
Application Papers	·					
9) The specification is objected to by the Examine 10) The drawing(s) filed on 14 February 2002 is/are Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Ex	e: a)⊠ accepted or b)⊡ objecte drawing(s) be held in abeyance. Se tion is required if the drawing(s) is ob	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).				
· —	ammer. Note the attached Office	Action of form 1 10-102.				
Priority under 35 U.S.C. § 119  12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some c) None of:  1. Certified copies of the priority documents have been received.  2. Certified copies of the priority documents have been received in Application No.  3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.						
Attachment(s)  1) Notice of References Cited (PTO-892)  2) Notice of Draftsperson's Patent Drawing Review (PTO-948)  3) Information Disclosure Statement(s) (PTO/SB/08)  Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal F 6) Other:	ate				

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#### **DETAILED ACTION**

### Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1, 2, 9, 11, 12, 17, 18, 20 and 21 are rejected under 35 U.S.C. 102(b) as being anticipated by Kono et al. '756.

Kono discloses a semiconductor device, comprising: a substrate (fig. 1, 102) having a first circuit formed therein (col. 6, lines 34-37; row decoder), a second circuit formed therein (column decoder), and a fuse (fig. 1, 130), wherein: the first circuit has a first contact area, the second circuit has a second contact area (fuse 130 connected at ports of row/column decoder); and the fuse, which may be selectively open-circuited, is formed overlying the passivation layer (fig. 1, 124), the fuse having a third contact area which is electrically coupled to the first contact area of the first circuit, and the fuse having a fourth contact area which is electrically coupled to the second contact area of the second circuit (col. 6, lines 34-37; fuse 130 connected at ports of row/column decoder), wherein the first contact area of the first circuit and the second contact area of the second circuit are no longer electrically connected if the fuse is open-circuited (col. 6, lines 37-38); a first interconnect for electrically connecting the first contact area to a first portion of the fuse; and a second interconnect for electrically connecting the second contact area to a second portion of the fuse (col. 6, lines 34-37; fuse 130 connected at ports of

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row/column decoder), a passivation layer (124) formed overlying at least a portion of the substrate, wherein the fuse is formed overlying the passivation layer; and a packaging material formed in contact with over the fuse (col. 11, lines 33-39; fuse is opened and entire chip is packaged in resin, thus covering the exposed areas of the fuse show in fig. 1), wherein the packaging material is selected from the group consisting of a mold compound (resin) and an underfill; wherein the fuse is electrically connected to only the circuitry, and is not electrically connected to anything external to the circuitry (col. 6, lines 34-37; only electrically connected to the row/column decoder circuitry); wherein the first contact area of the first circuit and the second contact area of the second circuit are electrically connected only by way of the fuse (row/column decoder circuitry only connected by fuse); blowing the fuse before forming a packaging material (col. 11, lines 33-37), wherein the packaging material is formed on the fuse (col. 11, lines 37-39); and wherein a recessed area is formed in the passivation layer and wherein at least a portion of the fuse is formed in the recessed area (fig. 13, passivation 150; fuse formed in opening 152).

## Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

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4. Claims 3-7 and 13-16 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kono et al. '756 in view of Weber et al. '279.

Kono discloses all of the elements of the claim(s) as set forth in paragraph # above, but the reference does not explicitly disclose the fuse to comprise aluminum and a metal nitride having a thickness less than approximately 1 micron. Weber discloses a fuse comprising titanium nitride and aluminum (col. 2, lines 24-25 & col. 4, lines 22-24).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to use the fuse material of Weber in the semiconductor device of Kono. One would have been motivated to do this in order to benefit from the novel properties of the fuse such as an adjustable resistance and easy manufacturing (Weber, col. 2, lines 7-12).

### Response to Arguments

5. Applicant's arguments with respect to claims 1-7, 9, 11-18, 20 and 21 have been considered but are most in view of the new ground(s) of rejection.

### Conclusion

6. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Dana Farahani whose telephone number is (571) 272-1706. The examiner can normally be reached on Monday through Friday, 9am-5pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Bill Baumeister can be reached on (571) 272-1722. The fax

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phone number for the organization where this application or proceeding is assigned is 571-273-8300.

7. Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

July 18, 2007 sjf

B. WILLIAM RAUMEISTER

SUPERVISORY PATENT EXAMINER

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